

Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- Ideally suited for use in very high frequency switching power supplies, inverters and as a free wheeling diode
- Ultrafast recovery time for high efficiency
- For surface mount applications
- Glass passivated junction
- High temperature soldering guaranteed: 260°C/10Seconds on terminals



DO-214AA(SMB)

Mechanical Data

- Case: JEDEC DO-214AA (SMB) molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026



Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	MURS140	MURS160	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	400	600	V
Working Peak Reverse Voltage	V_{RWM}	400	600	V
Maximum DC Blocking Voltage	V_{DC}	400	600	V
Maximum Average Forward Rectified Current at T_L (See Fig.1)	$T_L=150^\circ\text{C}$	$I_{F(AV)}$	1.0	A
	$T_L=125^\circ\text{C}$		2.0	
Peak Forward Surge Current 8.3ms Single Half Sine-wave Superimposed on Rated Load	I_{FSM}	35		A
Operating Junction Temperature Range	T_J	- 55 to + 150		°C
Storage Temperature Range	T_{STG}	- 55 to + 150		°C

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Conditions	MURS140	MURS160	Unit
Maximum Instantaneous Forward Voltage	V_F	$I_F=1.0\text{A}, T_J=25^\circ\text{C}$	1.25		Volts
		$I_F=1.0\text{A}, T_J=150^\circ\text{C}$	1.05		
Maximum DC reverse Current at Rated DC Blocking Voltage	I_R	$T_A=25^\circ\text{C}$	5.0		μA
		$T_A=125^\circ\text{C}$	50		
Typical Reverse Recovery Time	t_{rr}	$I_F=0.5\text{A}, I_R=1.0\text{A}, I_{rr}=0.25\text{A}$	50		nS
		$I_F=1.0\text{A}, \text{di}/\text{dt}=50\text{A/uS}, V_R=30\text{V}, I_{rr}=10\%I_{RM}$	75		nS
		$I_F=1.0\text{A}, \text{di}/\text{dt}=100\text{A/uS}, \text{Recovery to } 1.0\text{V}$	50		nS
Typical Thermal Resistance ¹	$R_{\theta JA}$	Junction to Ambient	85		°C/W
	$R_{\theta JC}$	Junction to Case	15		
	$R_{\theta JL}$	Junction to Lead	20		

Note:

- The thermal resistance from junction to ambient, case or lead, mounted on P.C.B with 8.0×8.0mm copper pads.

Ratings and Characteristics Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

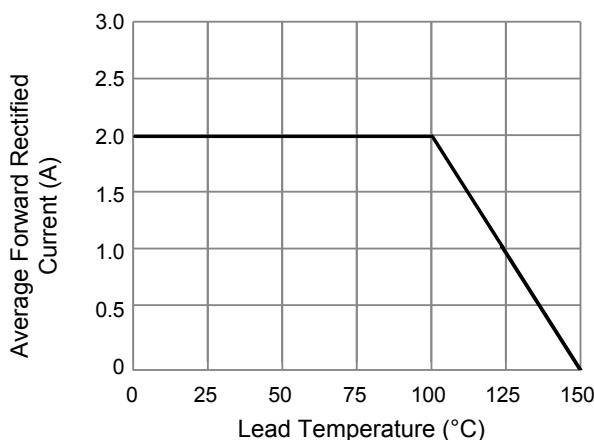


Figure 1. Forward Current Derating Curve

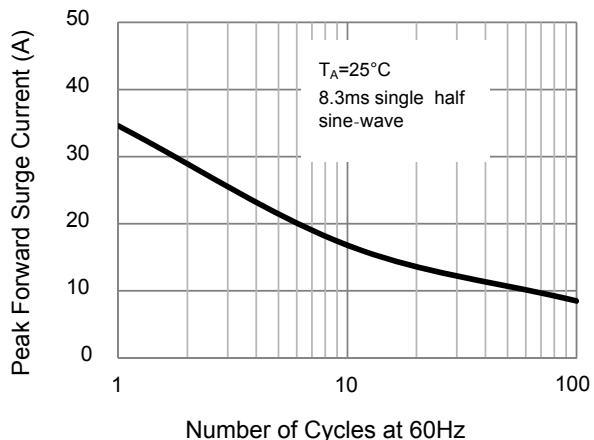


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

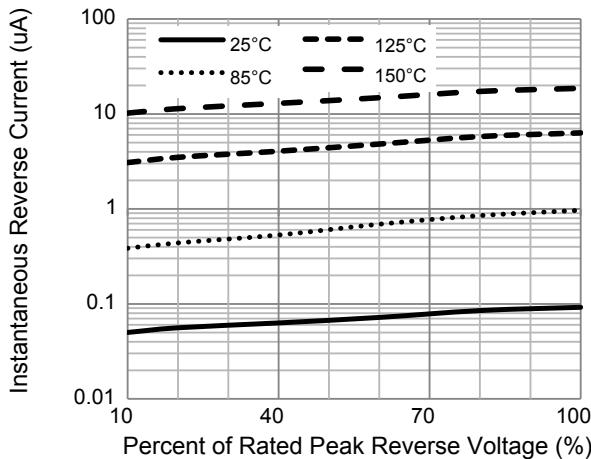


Figure 3. Typical Reverse Characteristics

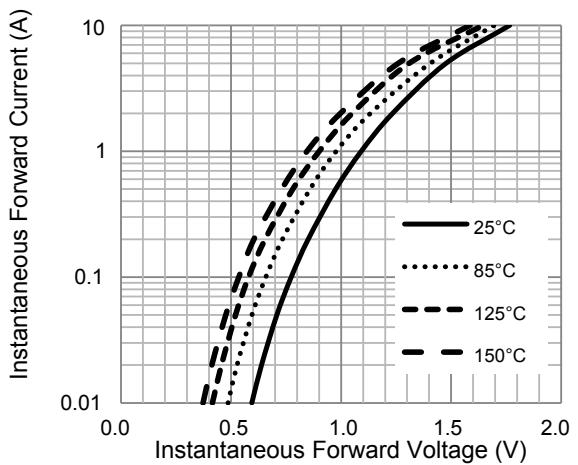


Figure 4. Typical Forward Characteristics

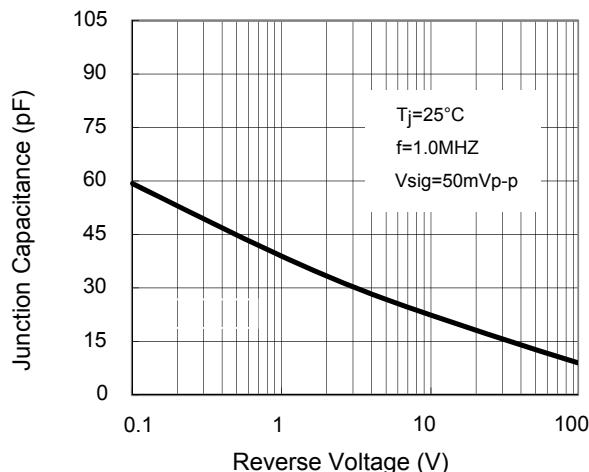
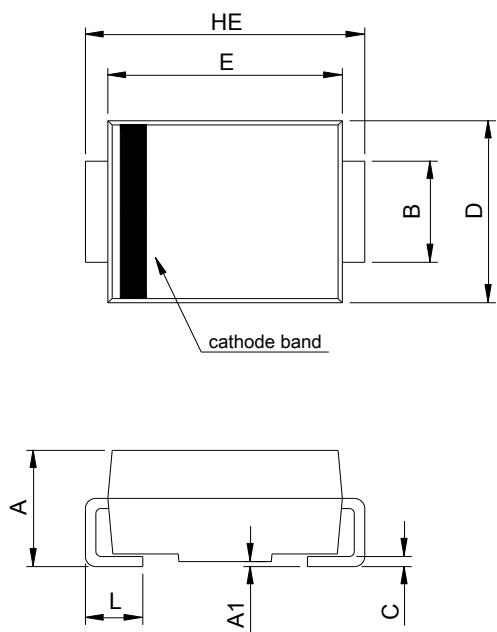


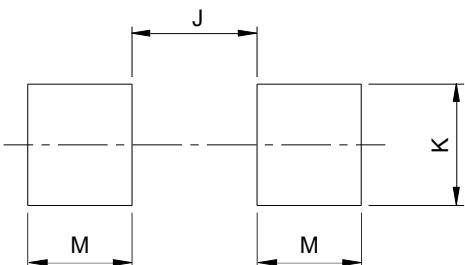
Figure 5. Typical Junction Capacitance

Package Outline Dimensions (SMB)



SMB (DO-214AA)				
DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.95	2.65	0.077	0.104
A1	0.00	0.20	0.000	0.008
B	1.95	2.20	0.077	0.087
C	0.15	0.31	0.006	0.012
D	3.30	3.95	0.130	0.156
E	4.06	4.60	0.160	0.181
HE	5.10	5.60	0.201	0.220
L	0.76	1.60	0.030	0.063

Recommended Pad Layout



Recommended Pad Layout (Reference ONLY)				
DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.
J	-	2.60	-	0.102
K	2.20	-	0.087	-
M	1.80	-	0.071	-